

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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TECHNOLOGY CENTER 2800

Applicants: Hua Ji
Assignee: Mosel Vitelic, Inc.
Title: HDP CVD Process For Void-Free Gap Fill Of A High Aspect Ratio Trench
Serial No.: 10/080,468 Filing Date: February 22, 2002
Examiner: Anh D. Mai Group Art Unit: 2814
Docket No.: M-12589 US

Irvine, California
February 7, 2003

COMMISSIONER FOR PATENTS
Washington, D. C. 20231

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

UNDER 37 C.F.R. §1.97

Dear Sir:

Pursuant to 37 C.F.R. §1.97, Applicant wishes to call the following documents (copies enclosed) to the attention of the Examiner.

1. A PTO form 1449 listing these documents is enclosed.

Citation of the above documents shall not be construed as:

1. an admission that the documents are necessarily prior art with respect to the instant invention;

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2. a representation that a search has been made, or

3. an admission that the information cited herein is, or is considered to be

material to patentability as defined in §1.56(b).

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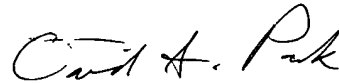
This IDS is being filed after the mailing date of the first Office Action and after three months of the filing date, but prior to the Notice of Allowance or Final Office Action.

The Commissioner is authorized to deduct \$180.00 from the undersigned's Deposit Account No. 50-2257. Please deduct any additional fees from, or credit any overpayment to the above-noted Deposit Account.

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Respectfully submitted,



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